

5

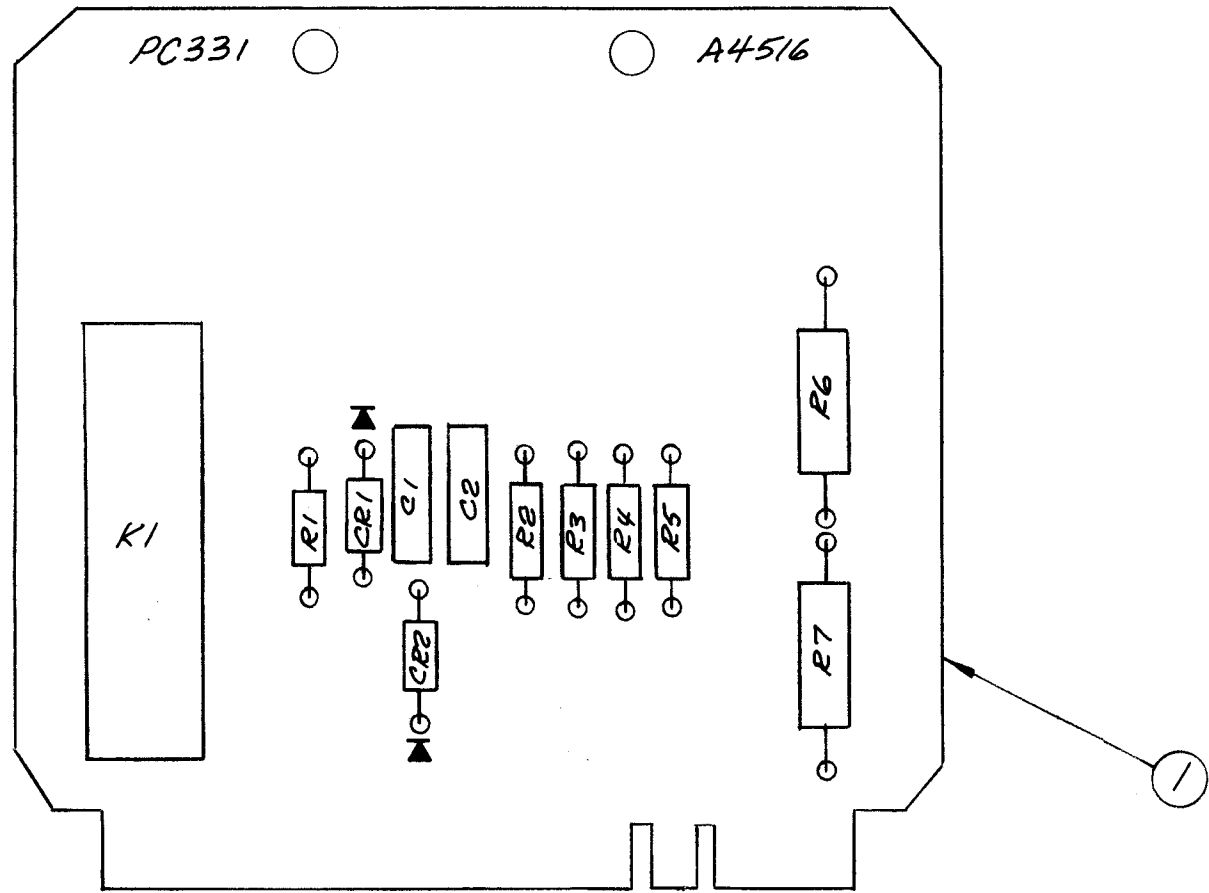
4

3

2

1

REVISIONS						
ZONE	LTR	DESCRIPTION	DATE	E.M.N.NO	DRAFT	CHKD APPD
	1	ORIG RELEASE FOR PROD	7/13/69			W
	A	REDRAWN FROM PHOTO	10/21/70	20049		W JEA



ASSEMBLY NOTES

1. TO MOUNT COMPONENTS INSERT LEAD THROUGH PLATED THRU-HOLES.
2. CAUTION: WHEN APPLYING HEAT AND SOLDER TO LEAD AND FOIL
3. CLEAN AND INSPECT AS PER TMC SPEC S676.
4. FOR ELECTRICAL COMPONENT PART NUMBERS REFER TO NPL A4516
5. USE SYMBOL NUMBERS FOR ASSEMBLY REFERENCE.

REQ'D	ITEM	PART NUMBER	DESCRIPTION	SYM.
X	2	BS 100	SOLDER TIN ALLOY	
1	1	PC331	PRINTED CIRCUIT BOARD	

LIST OF MATERIAL

UNLESS OTHERWISE SPECIFIED DIMENSIONS ARE IN INCHES AND INCLUDE CHEMICALLY APPLIED OR PLATED FINISHES		FINAL APPROVAL S. DeMARCO	DATE	THE TECHNICAL MATERIEL CORP. MAMARONECK, NEW YORK			
		MECH. DES. R. OZZO	DATE				
		ELECT. DES.	DATE				
		CHECKED W	DATE				
		DRAWN	DATE	PC331 ASSEMBLY			
					KEYER CIRCUIT		
		SIZE B	CODE IDENT. NO.	DWG NO. A 4516	ISSUE A		
		SCALE			SHEET OF		

RTPH-3		
QTY / UNIT	MODEL USED ON	ASS'Y NO.
APPLICATION		
	CODE A	S401-451

NOTICE TO PERSONS RECEIVING THIS DRAWING
 THE TECHNICAL MATERIEL CORPORATION claims proprietary right in the material disclosed hereon. This drawing is issued in confidence for engineering information only and may not be reproduced or used to manufacture anything shown hereon without permission from THE TECHNICAL MATERIEL CORPORATION to the user. This drawing is loaned for mutual assistance and is subject to recall at any time.

6-170
 5-35